# Fixed Frequency Current Mode Controller for Flyback Converters

The NCP12400 is a new fixed-frequency current-mode controller featuring the Dynamic Self-Supply. This function greatly simplifies the design of the auxiliary supply and the  $V_{CC}$  capacitor by activating the internal startup current source to supply the controller during start-up, transients, latch, stand-by etc. This device contains a special HV detector which detects the application unplug from the ac input line and triggers the X2 discharge current. This HV structure allows the brown-out detection as well.

It features a timer–based fault detection that ensures the detection of overload and an adjustable compensation to help keep the maximum power independent of the input voltage.

Due to frequency foldback, the controller exhibits excellent efficiency in light load condition while still achieving very low standby power consumption. Internal frequency jittering, ramp compensation, and a versatile latch input make this controller an excellent candidate for the robust power supply designs.

A dedicated Off Mode allows to reach the extremely low no load input power consumption via "sleeping" whole device and thus minimize the power consumption of the control circuitry.

## Features

- Fixed-Frequency Current-Mode Operation (65 kHz Switching Frequency Option)
- Frequency Foldback then Skip Mode for Maximized Performance in Light Load and Standby Conditions
- Timer-Based Overload Protection with Latched (Option A) or Autorecovery (Option B) Operation
- High–Voltage Current Source with Brown–Out Detection and Dynamic Self–Supply, Simplifying the Design of the V<sub>CC</sub> Circuitry
- Frequency Modulation for Softened EMI Signature
- Adjustable Overpower Protection Dependant on the Mains Voltage
- Fault Input for Overvoltage and Over Temperature Protection
- V<sub>CC</sub> Operation up to 28 V, with Overvoltage Detection
- 500/800 mA Source/Sink Drive Peak Current Capability
- 4 ms Soft-Start
- Internal Thermal Shutdown
- No-Load Standby Power < 30 mW
- X2 Capacitor in EMI Filter Discharging Feature
- These are Pb-Free Devices

## **Typical Applications**

- Offline Adapters for Notebooks, LCD, and Printers
- Offline Battery Chargers
- Consumer Electronic Power Supplies
- Auxiliary/Housekeeping Power Supplies
- Offline Adapters for Notebooks

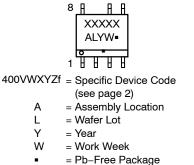


## **ON Semiconductor®**

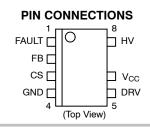
www.onsemi.com



# MARKING DIAGRAM



(Note: Microdot may be in either location)



### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NCP12400BA-	SOIC-7	Tape &
HAB0DR2G	(Pb-Free)	Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## TYPICAL APPLICATION SCHEMATIC

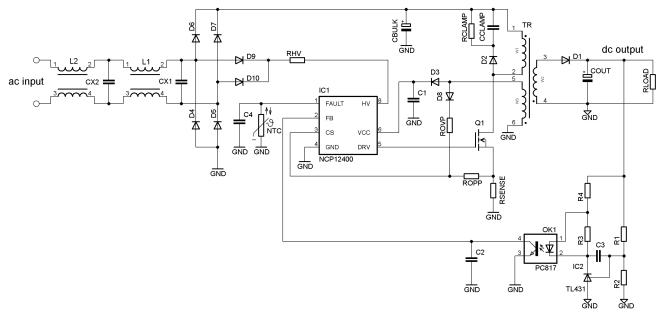


Figure 1. Flyback Converter Application using the NCP12400

## Table 1. Options

Part	OPN	Brown Out Start-Stop	OCP Fault	Frozen Current Setpoint	Quiet Skip	Soft Start	Frequency
NCP12400	NCP12400BAHAB 0DR2G	103 – 96 V	Latched	300 mV	No, min. 3 pulses only	4 ms	65 kHz

### Table 2. Specific Device Code Key

400	v	w	х	Y	Z	f
Part	BO	OCP Fault	Frozen Current Setpoint	Quiet Skip	Soft Start	Frequency
	A - 229-211 V B - 111-103 V C - 95-87 V D - No BO E - Brown In, no BO	A – Latched B – Autorecovery	A -No B - 150 mV C - 170 mV D - 190 mV E - 210 mV F - 230 mV G - 250 mV H - 300 mV	A – No, min. 3 pulses B – Yes, min. 3 pulses, 800 Hz burst	A – 10 ms B – 4 ms	0 – 65 kHz 1 – 100 kHz 2 – 65 → 100 kHz

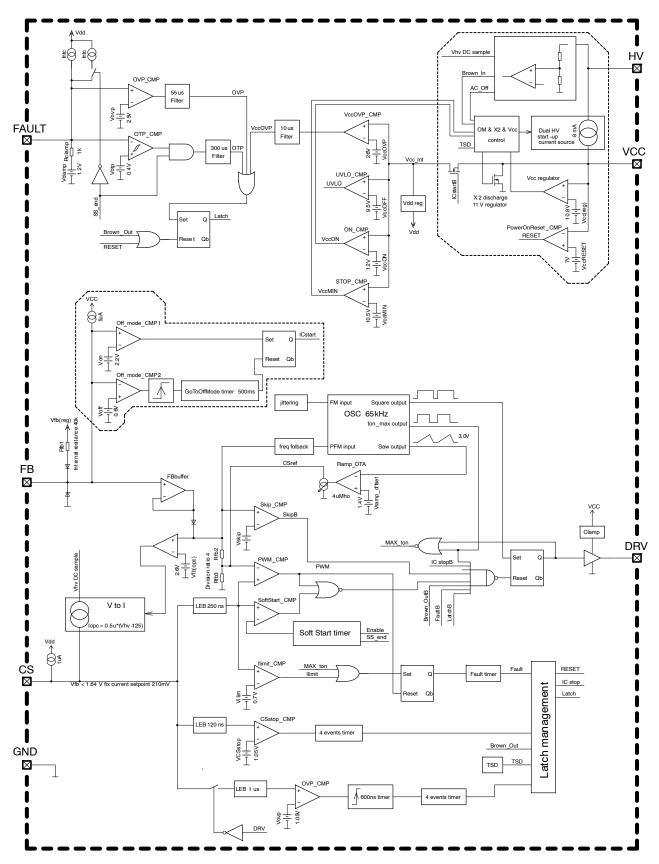
## Table 3. PIN FUNCTION DESCRIPTION

Pin #	Pin Name	Function	Pin Description
1	FAULT	FAULT Input	Pull the pin up or down to stop the controller. An internal current source allows the direct connection of an NTC for over temperature detection. Device can restart in autorecovery mode or can be latched depending on the option.
2	FB	Feedback + Shutdown Pin	An optocoupler collector to ground controls the output regulation. The part goes to the low consumption Off mode if the FB input pin is pulled to GND.
3	CS	Current Sense	This input senses the primary current for current-mode operation, and offers an overpower compensation adjustment. This pin implements over voltage protection as well.

## Table 3. PIN FUNCTION DESCRIPTION

Pin #	Pin Name	Function	Pin Description
4	GND		The controller ground.
5	DRV	Drive Output	Drives external MOSFET.
6	V <sub>CC</sub>	V <sub>CC</sub> Input	This supply pin accepts up to 28 Vdc, with overvoltage detection. The pin is connected to an external auxiliary voltage.
8	HV	High-Voltage Pin	Connects to the rectified ac line to perform the functions of start-up current source, Self-Supply, brown-out detection and X2 capacitor discharge function and the HV sensing for the overpower protection purposes. It is not allowed to connect this pin to a dc voltage.

## SIMPLIFIED INTERNAL BLOCK SCHEMATIC





#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
DRV (pin 5)	Maximum voltage on DRV pin (Dc-Current self-limited if operated within the allowed range) (Note 2)	−0.3 to 20 ±1000 (peak)	V mA
V <sub>CC</sub> (pin 6)	V <sub>CC</sub> Power Supply voltage, V <sub>CC</sub> pin, continuous voltage Power Supply voltage, V <sub>CC</sub> pin, continuous voltage (Note 2)	-0.3 to 28 ±30 (peak)	V mA
HV (pin 8)	Maximum voltage on HV pin (Dc–Current self–limited if operated within the allowed range)	-0.3 to 500 ±20	V mA
V <sub>max</sub>	Maximum voltage on low power pins (except pin 5, pin 6 and pin 8) (Dc-Current self-limited if operated within the allowed range) (Note 2)	−0.3 to 5.5 ±10 (peak)	V mA
$R_{\theta J-A}$	Thermal Resistance SOIC-7 Junction-to-Air, low conductivity PCB (Note 3) Junction-to-Air, medium conductivity PCB (Note 4) Junction-to-Air, high conductivity PCB (Note 5)	162 147 115	°C/W
$R_{\theta J-C}$	Thermal Resistance Junction-to-Case	73	°C/W
T <sub>JMAX</sub>	Operating Junction Temperature	-40 to +150	°C
T <sub>STRGMAX</sub>	Storage Temperature Range	-60 to +150	°C
	ESD Capability, HBM model (All pins except HV) (Note 1)	> 4000	V
	ESD Capability, HBM model (pin 8, HV)	> 2000	V
	ESD Capability, Charge Discharge Model (Note 1)	> 500	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. This device series contains ESD protection and exceeds the following tests: Human Body Model 4000 V per JEDEC standard JESD22, Method A114E

Charge Discharge Model Method 500 V per JEDEC standard JESD22, Method C101E

 This device contains latch-up protection and exceeds 100 mA per JEDEC Standard JESD78.
 As mounted on a 80 x 100 x 1.5 mm FR4 substrate with a single layer of 50 mm<sup>2</sup> of 2 oz copper traces and heat spreading area. As specified for a JEDEC 51-1 conductivity test PCB. Test conditions were under natural convection or zero air flow.

4. As mounted on a 80 x 100 x 1.5 mm FR4 substrate with a single layer of 100 mm<sup>2</sup> of 2 oz copper traces and heat spreading area. As specified for a JEDEC 51-2 conductivity test PCB. Test conditions were under natural convection or zero air flow.

5. As mounted on a 80 x 100 x 1.5 mm FR4 substrate with a single layer of 650 mm<sup>2</sup> of 2 oz copper traces and heat spreading area. As specified for a JEDEC 51-3 conductivity test PCB. Test conditions were under natural convection or zero air flow.

#### Table 4. ELECTRICAL CHARACTERISTICS

(For typical values  $T_{J} = 25^{\circ}$ C, for min/max values  $T_{J} = -40^{\circ}$ C to +125°C,  $V_{HV} = 125$  V,  $V_{CC} = 11$  V unless otherwise noted)

Characteristics	Test Condition	Symbol	Min	Тур	Max	Unit
HIGH VOLTAGE CURRENT SOURCE						
Minimum voltage for current source operation		V <sub>HV(min)</sub>	-	30	40	V
Current flowing out of $V_{CC}\ pin$	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 0 \ V \\ V_{CC} = V_{CC(on)} - 0.5 \ V \end{array}$	I <sub>start1</sub> I <sub>start2</sub>	0.2 5	0.5 8	0.8 11	mA
Off-state leakage current	$V_{HV}$ = 500 V, $V_{CC}$ = 15 V	I <sub>start(off)</sub>	-	2	6	μA
SUPPLY						
Turn-on threshold level, V <sub>CC</sub> going up HV current source stop threshold		V <sub>CC(on)</sub>	11.0	12.0	13.0	V
HV current source restart threshold		V <sub>CC(min)</sub>	9.5	10.5	11.5	V
Turn-off threshold		V <sub>CC(off)</sub>	8.4	8.9	9.3	V
Overvoltage threshold		V <sub>CC(ovp)</sub>	25	26.5	28	V
Blanking duration on $V_{CC(off)}$ and $V_{CC(ovp)}$ detection		t <sub>VCC(blank)</sub>	-	10	-	μs
$V_{CC}$ decreasing level at which the internal logic resets		V <sub>CC(reset)</sub>	4.8	7.0	7.7	V
$V_{CC}$ level for $I_{START1}$ to $I_{START2}$ transition		V <sub>CC(inhibit)</sub>	1.0	2.1	3.0	V
Internal current consumption	DRV open, V <sub>FB</sub> = 3 V, 65 kHz	I <sub>CC1</sub>	1.0	1.3	2.0	mA
	Cdrv = 1 nF, V <sub>FB</sub> = 3 V, 65 kHz	I <sub>CC2</sub>	1.5	2.1	2.9	mA
	Skip or before start-up	I <sub>CC3</sub>	400	500	650	μA
	Fault mode (fault or latch)	I <sub>CC4</sub>	300	430	550	μA
	Off-mode		_	25	_	μΑ
BROWN-OUT	OII-III0de	I <sub>CC5</sub>	_	20	_	μΑ
		N N	00	102	110	V
Brown-out thresholds	V <sub>HV</sub> going up V <sub>HV</sub> going down	V <sub>HV(start)</sub> V <sub>HV(stop)</sub>	93 90	103 100	113 110	V
Timer duration for line cycle drop-out		t <sub>HV</sub>	42	64	86	ms
X2 DISCHARGE						
Comparator hysteresis observed at HV pin		V <sub>HV(hyst)</sub>	2.0	3.0	4.0	V
HV signal sampling period		t <sub>sample</sub>	-	1.0	-	ms
Timer duration for no line detection		t <sub>DET</sub>	21	32	43	ms
Discharge timer duration		t <sub>DIS</sub>	21	32	43	ms
Shunt regulator voltage at VCC pin during X2 discharge event		V <sub>CC(dis)</sub>	10.0	11.0	12.0	V
OSCILLATOR						
Oscillator frequency		f <sub>OSC</sub>	61	65	69	kHz
Maximum duty-ratio (corresponding to maximum on time at maximum switching frequency)		D <sub>MAX</sub>	75	80	85	%
Frequency jittering amplitude, in percentage of $F_{\mathrm{OSC}}$		A <sub>jitter</sub>	±3.0	±4.0	±5.0	kHz
Frequency jittering modulation frequency		F <sub>jitter</sub>	85	125	165	Hz

Guaranteed by design.
 CS pin source current is a sum of I<sub>bias</sub> and I<sub>OPC</sub>, thus at V<sub>HV</sub> = 125 V is observed the I<sub>bias</sub> only, because I<sub>OPC</sub> is switched off.

## Table 4. ELECTRICAL CHARACTERISTICS

(For typical values  $T_J = 25^{\circ}C$ , for min/max values  $T_J = -40^{\circ}C$  to  $+125^{\circ}C$ ,  $V_{HV} = 125$  V,  $V_{CC} = 11$  V unless otherwise noted)

Test Condition	Symbol	Min	Тур	Max	Unit
$T_J = 25^{\circ}C$	V <sub>FB(foldS)</sub>	2.4	2.5	2.6	V
T <sub>J</sub> = 25°C	V <sub>FB(foldE)</sub>	2.05	2.15	2.25	V
$V_{FB} = V_{skip(in)} + 0.1$	f <sub>OSC(min)</sub>	25	28	31	kHz
$V_{CC} = V_{CC(off)} + 0.2 V,$ $C_{DRV} = 1 nF$	t <sub>rise</sub>	-	40	70	ns
$V_{CC} = V_{CC(off)} + 0.2 V,$ $C_{DRV} = 1 nF$	t <sub>fall</sub>	-	30	60	ns
$\label{eq:V_CC} \begin{array}{l} V_{CC} = V_{CC(off)} + 0.2 \text{ V}, \\ C_{DRV} = 1 \text{ nF} \\ \text{DRV high, } V_{DRV} = 0 \text{ V} \\ \text{DRV low, } V_{DRV} = V_{CC} \end{array}$	I <sub>DRV(source)</sub> I <sub>DRV(sink)</sub>		300 500		mA
$V_{CC}$ = $V_{CC(ovp)} -$ 0.2 V, DRV high, $R_{DRV}$ = 33 k $\Omega,~C_{load}$ = 220 pF	V <sub>DRV(clamp)</sub>	10	12	14	V
$V_{CC}$ = $V_{CC(min)}$ + 0.2 V, R <sub>DRV</sub> = 33 kΩ, DRV high	V <sub>DRV(drop)</sub>	-	_	1	V
V <sub>CS</sub> = 0.7 V	I <sub>bias</sub>	-	1	-	μA
V <sub>FB</sub> > 3.5 V	V <sub>ILIM</sub>	0.66	0.70	0.74	V
V <sub>CS</sub> = V <sub>ILIM</sub>	t <sub>delay</sub>	-	50	70	ns
	t <sub>LEB</sub>	180	250	320	ns
	V <sub>CS(stop)</sub>	0.95	1.05	1.15	V
	t <sub>BCS</sub>	75	120	150	ns
From 1 <sup>st</sup> pulse to $V_{CS} = V_{ILIM}$	t <sub>SSTART</sub>	3.2	4.0	4.8	ms
	V <sub>I(freeze)</sub>	250	300	350	mV
V <sub>CS</sub> going up	V <sub>OVP(CS)</sub>	1.00	1.05	1.10	V
	t <sub>OVP,CS</sub>	0.7	1.0	1.3	μs
	t <sub>OVP,del</sub>	-	600	-	ns
	S <sub>comp(65kHz)</sub> S <sub>comp(100kHz)</sub>	1 1	-32.5 -50	_	mV / μs
$T_J = 25^{\circ}C$	R <sub>FB(up)</sub>	30	40	50	kΩ
	K <sub>FB</sub>	-	4	-	-
	V <sub>FB(ref)</sub>	4.5	5	5.5	V
$T_{\rm J} = 25^{\circ} \rm C$	V <sub>FB(off)</sub>	-	0.8	-	V
	$T_{J} = 25^{\circ}C$ $T_{J} = 25^{\circ}C$ $V_{FB} = V_{skip(in)} + 0.1$ $V_{CC} = V_{CC(off)} + 0.2 V,$ $C_{DRV} = 1 nF$ $V_{CC} = V_{CC(off)} + 0.2 V,$ $C_{DRV} = 1 nF$ $DRV high, V_{DRV} = 0 V$ $DRV low, V_{DRV} = V_{CC}$ $V_{CC} = V_{CC(ovp)} - 0.2 V, DRV high,$ $R_{DRV} = 33 k\Omega, C_{load} = 220 pF$ $V_{CC} = V_{CC(min)} + 0.2 V,$ $R_{DRV} = 33 k\Omega, DRV high$ $V_{CS} = 0.7 V$ $V_{FB} > 3.5 V$ $V_{CS} = V_{ILIM}$ From 1 <sup>st</sup> pulse to V_{CS} = V_{ILIM} $T_{J} = 25^{\circ}C$	$\begin{tabular}{ c c c c } \hline T_J = 25^\circ C & V_{FB(foldS)} \\ \hline T_J = 25^\circ C & V_{FB(foldE)} \\ \hline V_{FB} = V_{skip(in)} + 0.1 & f_{OSC(min)} \\ \hline V_{CC} = V_{CC(off)} + 0.2 V, & t_{rise} \\ \hline V_{CC} = V_{CC(off)} + 0.2 V, & t_{fall} \\ \hline V_{CC} = V_{CC(off)} + 0.2 V, & t_{fall} \\ \hline V_{CC} = V_{CC(off)} + 0.2 V, & t_{fall} \\ \hline V_{CC} = V_{CC(off)} + 0.2 V, & t_{fall} \\ \hline V_{CC} = V_{CC(off)} + 0.2 V, & t_{fall} \\ \hline V_{CC} = V_{CC(off)} - 0.2 V, DRV high, & V_{DRV(source)} \\ DRV high, V_{DRV} = 0 V & I_{DRV(sink)} \\ \hline V_{CC} = V_{CC(orp)} - 0.2 V, DRV high, & V_{DRV(sink)} \\ \hline V_{CC} = V_{CC(orp)} - 0.2 V, DRV high, & V_{DRV(clamp)} \\ \hline V_{CC} = V_{CC(orp)} - 0.2 V, DRV high, & V_{DRV(clamp)} \\ \hline V_{CC} = V_{CC(orp)} - 0.2 V, DRV high, & V_{DRV(drop)} \\ \hline V_{CC} = V_{CC(orp)} - 0.2 V, DRV high, & V_{DRV(drop)} \\ \hline V_{CC} = V_{CC(orp)} - 0.2 V, DRV high, & V_{DRV(drop)} \\ \hline V_{CC} = V_{CC(orp)} - 0.2 V, DRV high, & V_{DRV(clamp)} \\ \hline V_{CS} = 0.7 V & I_{bias} \\ \hline V_{CS} = 0.7 V & I_{bias} \\ \hline V_{CS} = 0.7 V & I_{bias} \\ \hline V_{CS} = V_{ILIM} & t_{delay} \\ \hline \hline V_{CS} = V_{ILIM} & t_{delay} \\ \hline & t_{LEB} \\ \hline V_{CS} = V_{ILIM} & t_{delay} \\ \hline & t_{BCS} \\ \hline From 1^{st} pulse to V_{CS} = V_{ILIM} & t_{SSTART} \\ \hline V_{CS} going up & V_{OVP(CS)} \\ \hline & t_{OVP,CS} \\ \hline & t_{OVP,CS} \\ \hline & t_{OVP,CS} \\ \hline \hline T_{J} = 25^\circ C & R_{FB(up)} \\ \hline K_{FB} \\ \hline \end{array}$	$\begin{tabular}{ c c c c c c } \hline T_J = 25^\circ C & V_{FB}(foldS) & 2.4 \\ \hline T_J = 25^\circ C & V_{FB}(foldE) & 2.05 \\ \hline V_{FB} = V_{skip}(n) + 0.1 & f_{OSC}(min) & 25 \\ \hline V_{CB} = V_{skip}(n) + 0.2 V, & trise & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & trial & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & - \\ \hline V_{CC} = V_{CC}(off) + 0.2 V, & V_{DRV}(source) & 0.95 \\ \hline V_{CS} = 0.7 V & I_{Dias} & - \\ \hline V_{CS} = 0.7 V & I_{Dias} & - \\ \hline V_{CS} = V_{ILIM} & t_{delay} & - \\ \hline V_{CS} = V_{ILIM} & t_{delay} & - \\ \hline V_{CS} = V_{ILIM} & t_{SSTART} & 3.2 \\ \hline V_{CS}(stop) & 0.95 \\ \hline V_{CS} going up & V_{OVP}(CS) & 1.00 \\ \hline V_{CS} going up & V_{OVP}(CS) & 1.00 \\ \hline V_{CS} going up & V_{OVP}(CS) & 1.00 \\ \hline T_{U} & T_{U} = 25^\circ C & R_{FB}(up) & 30 \\ \hline T_{U} & T_{U} = 25^\circ C & R_{FB}(up) & 30 \\ \hline T_{U} & T_{U} = 25^\circ C & R_{FB}(up) & 4.5 \\ \hline \end{array}$	$\begin{array}{c c c c c c c c c c c c c c c c c c c $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Guaranteed by design.
 CS pin source current is a sum of I<sub>bias</sub> and I<sub>OPC</sub>, thus at V<sub>HV</sub> = 125 V is observed the I<sub>bias</sub> only, because I<sub>OPC</sub> is switched off.

#### **Table 4. ELECTRICAL CHARACTERISTICS**

(For typical values  $T_J = 25^{\circ}C$ , for min/max values  $T_J = -40^{\circ}C$  to  $+125^{\circ}C$ ,  $V_{HV} = 125$  V,  $V_{CC} = 11$  V unless otherwise noted)

Characteristics	Test Condition	Symbol	Min	Тур	Max	Unit
SKIP CYCLE MODE						
Feedback voltage thresholds for skip mode	$V_{FB}$ going down, $T_J$ = 25°C $V_{FB}$ going up, $T_J$ = 25°C	V <sub>skip(in)</sub> V <sub>skip(out)</sub>	0.9 1.05	1.0 1.15	1.1 1.25	V
Minimum number of pulses in burst		n <sub>P,skip</sub>	3	-	-	
Skip out delay		t <sub>skip</sub>	-	-	38	μs
REMOTE CONTROL ON FB PIN						
The voltage above which the part enters the on mode	$V_{CC} > V_{CC(off)}, V_{HV} = 60 V$	V <sub>ON</sub>	-	2.2	-	V
The voltage below which the part enters the off mode	$V_{CC} > V_{CC(off)}$	V <sub>OFF</sub>	0.5	0.6	0.7	V
Minimum hysteresis between the $V_{\mbox{ON}}$ and $V_{\mbox{OFF}}$	$V_{CC} > V_{CC(off)}, V_{HV} = 60 V$	V <sub>HYST</sub>	500	_	-	mV
Pull-up current in off mode	V <sub>CC</sub> > V <sub>CC(off)</sub>	I <sub>OFF</sub>	-	5	-	μA
Go To Off mode timer	V <sub>CC</sub> > V <sub>CC(off)</sub>	t <sub>GTOM</sub>	400	500	600	ms
OVERLOAD PROTECTION						
Fault timer duration		t <sub>fault</sub>	108	128	178	ms
Fault timer reset time	V <sub>CS</sub> < 0.7 V, D < 90% D <sub>MAX</sub>	t <sub>fault,res</sub>	150	200	250	μs
OVERPOWER PROTECTION						-
V <sub>HV</sub> to I <sub>OPC</sub> conversion ratio		K <sub>OPC</sub>	-	0.54	-	μ <b>A</b> / V
Current flowing out of CS pin (Note 7)	V <sub>HV</sub> = 125 V V <sub>HV</sub> = 162 V V <sub>HV</sub> = 325 V V <sub>HV</sub> = 365 V	IOPC(125) IOPC(162) IOPC(325) IOPC(365)	- - - 105	0 20 110 130	- - - 150	μΑ
FB voltage above which I <sub>OPC</sub> is applied	V <sub>HV</sub> = 365 V	V <sub>FB(OPCF)</sub>	_	2.6	_	V
FB voltage below which is no IOPC applied	V <sub>HV</sub> = 365 V	V <sub>FB(OPCE)</sub>	_	1.6	-	V
FAULT INPUT	1					
High threshold	V <sub>Latch</sub> going up	V <sub>OVP</sub>	2.43	2.50	2.57	V
Low threshold	V <sub>Latch</sub> going down, T <sub>J</sub> = 25°C	V <sub>OTP</sub>	0.380	0.400	0.420	V
OTP resistance threshold (T <sub>J</sub> = 25°C)	External NTC resistance is going down	R <sub>OTP</sub>	7.6	8.0	8.5	kΩ
OTP resistance threshold (T <sub>J</sub> = 80°C)	External NTC resistance is going down	R <sub>OTP</sub>	_	8.5	-	kΩ
OTP resistance threshold (T <sub>J</sub> = $110^{\circ}$ C)	External NTC resistance is going down	R <sub>OTP</sub>	_	9.5	-	kΩ
Current source for direct NTC connection During normal operation During soft–start	V <sub>Latch</sub> = 0.2 V	I <sub>NTC</sub> I <sub>NTC</sub> (SSTART)	30 60	50 100	70 140	μΑ
Current source for direct NTC connection During normal operation	$V_{Latch}$ = 0.2 V, $T_J$ = 25°C	I <sub>NTC</sub>	47	50	53	μA
Blanking duration on high latch detection		t <sub>Latch(OVP)</sub>	35	50	70	μs
Blanking duration on low latch detection		t <sub>Latch(OTP)</sub>	-	350	-	μs
Clamping voltage	I <sub>Latch</sub> = 0 mA I <sub>Latch</sub> = 1 mA	V <sub>clamp0(Latch)</sub> V <sub>clamp1(Latch)</sub>	1.0 1.8	1.2 2.4	1.4 3.0	V
TEMPERATURE SHUTDOWN		•		•		

Temperature shutdown	T <sub>J</sub> going up	T <sub>TSD</sub>	_	150	1	°C
Temperature shutdown hysteresis	T <sub>J</sub> going down	T <sub>TSD(HYS)</sub>	-	30	-	°C

6. Guaranteed by design. 7. CS pin source current is a sum of  $I_{bias}$  and  $I_{OPC}$ , thus at  $V_{HV}$  = 125 V is observed the  $I_{bias}$  only, because  $I_{OPC}$  is switched off.

## **TYPICAL CHARACTERISTIC**

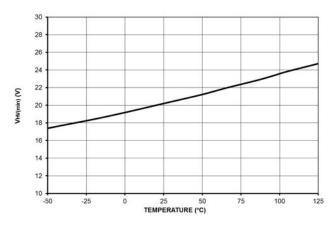


Figure 3. Minimum Voltage for HV Current Source Operation  $V_{HV(min)}$ 

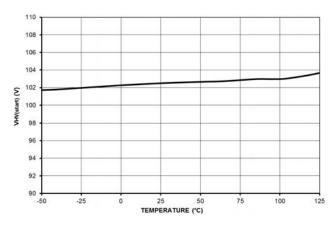
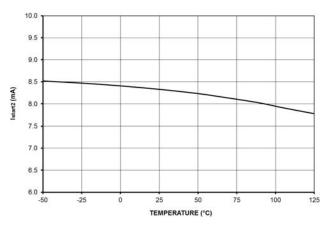


Figure 5. HV Pin Device Startup Threshold V<sub>HV(start)</sub>





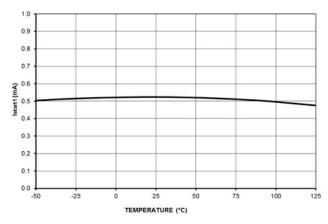


Figure 4. High Voltage Startup Current Flowing Out of  $V_{CC}$  Pin I<sub>start1</sub> of  $V_{CC}$  Pin Fault/Short

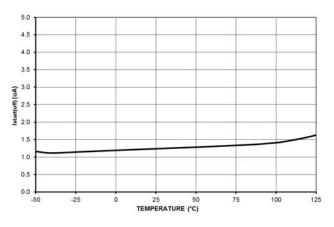


Figure 6. Off-state Leakage Current from HV Pin Istart(off)

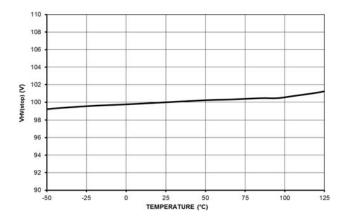
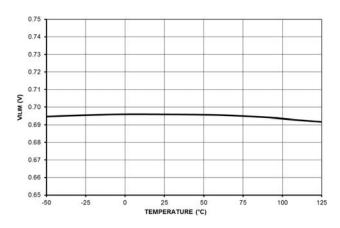


Figure 8. HV Pin Device Stop Threshold V<sub>HV(stop)</sub>





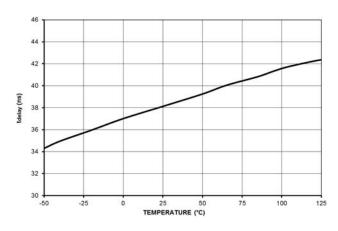


Figure 11. Propagation Delay t<sub>delay</sub>

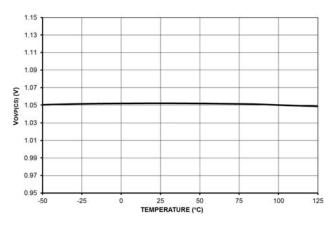


Figure 13. Over Voltage Protection Threshold at CS Pin  $V_{OVP(CS)}$ 

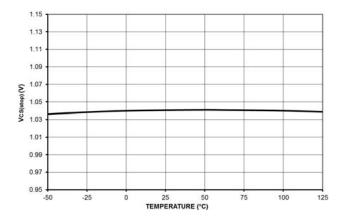


Figure 10. Threshold for the Very Fast Fault Protection Activation V<sub>CS(stop)</sub>

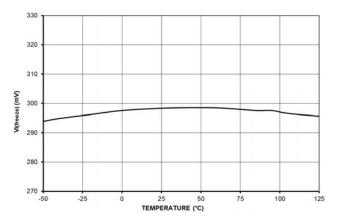


Figure 12. Frozen Current Setpoint  $V_{l(\mbox{freeze})}$  for the Light Load Operation

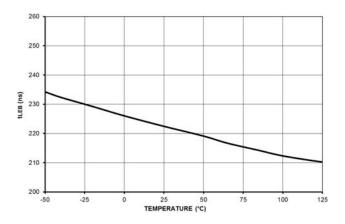


Figure 14. Leading Edge Blanking Duration tLEB

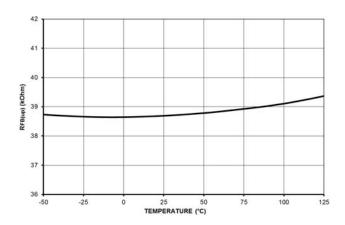


Figure 15. FB Pin Internal Pull–up Resistor R<sub>FB(up)</sub>

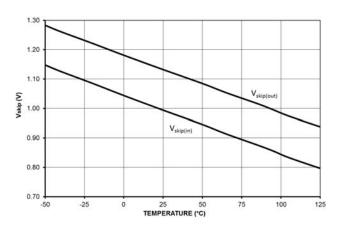


Figure 17. FB Pin Skip–In and Skip–Out Levels  $V_{skip(out)}$  and  $V_{skip(out)}$ 

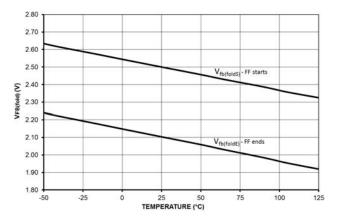


Figure 19. FB Pin Frequency Foldback Thresholds  $$V_{FB(foldS)}$$  and  $$V_{FB(foldE)}$$ 

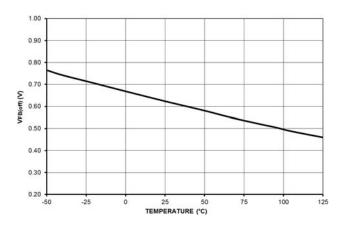


Figure 16. Built in Offset between FB Pin and Internal Divider V<sub>FB(off)</sub>

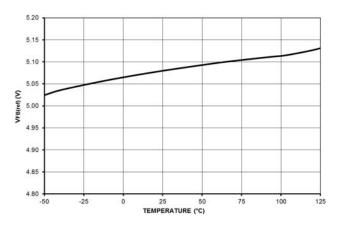


Figure 18. FB Pin Open Voltage V<sub>FB(ref)</sub>

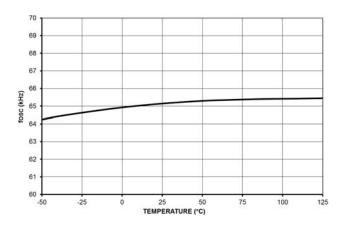


Figure 20. Oscillator Switching Frequency force

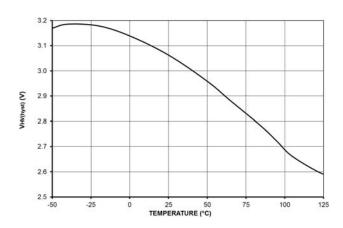
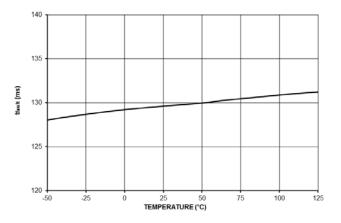


Figure 22. X2 Discharge Comparator Hysteresis Observed at HV Pin V<sub>HV(hyst)</sub>





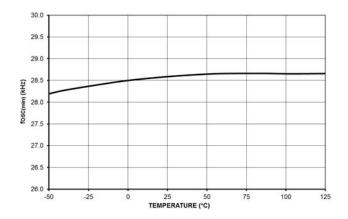


Figure 21. Minimum Switching Frequency f<sub>OSC(min)</sub>

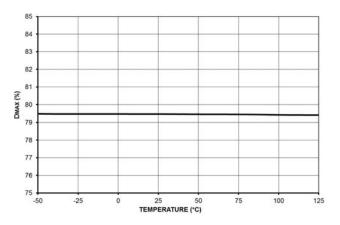


Figure 23. Maximum Duty Cycle D<sub>MAX</sub>

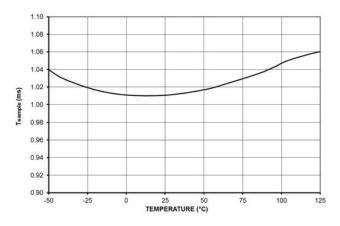


Figure 25. HV Signal Sampling Period T<sub>sample</sub>

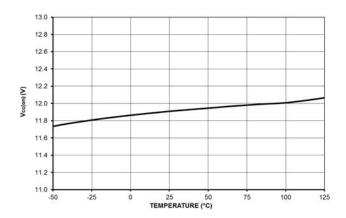


Figure 26. V<sub>CC</sub> Turn-on Threshold Level, V<sub>CC</sub> Going Up HV Current Source Stop Threshold V<sub>CC(on)</sub>

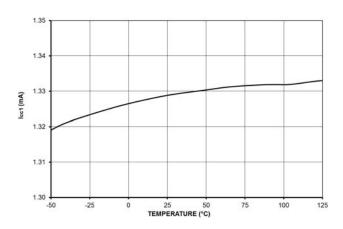


Figure 28. Internal Current Consumption when DRV Pin is Unloaded  $\rm I_{\rm CC1}$ 

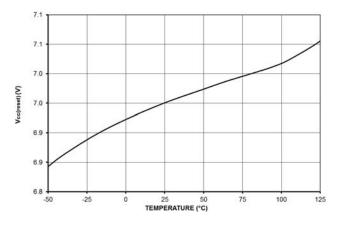


Figure 30. V<sub>CC</sub> Decreasing Level at which the Internal Logic Resets V<sub>CC(reset)</sub>

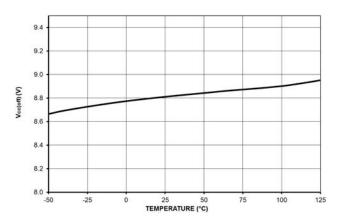


Figure 27. VCC Turn-off Threshold (UVLO) V<sub>CC(off)</sub>

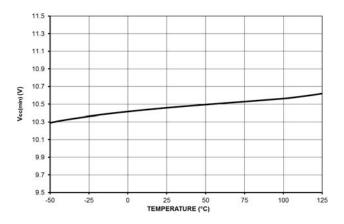


Figure 29. HV Current Source Restart Threshold V<sub>CC(min)</sub>

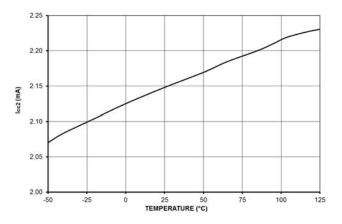


Figure 31. Internal Current Consumption when DRV Pin is Loaded by 1 nF Capacitance I<sub>CC2</sub>

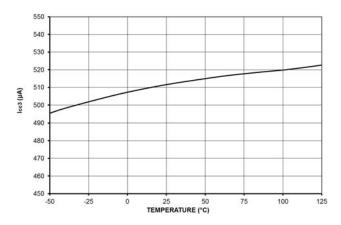


Figure 32. Internal Current Consumption in Skip Mode I<sub>CC3</sub>

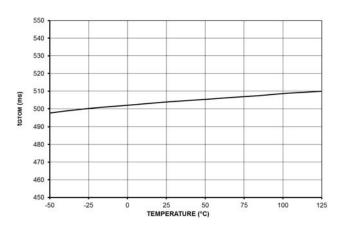


Figure 34. Go To Off Mode Timer Duration  $t_{GTOM}$ 

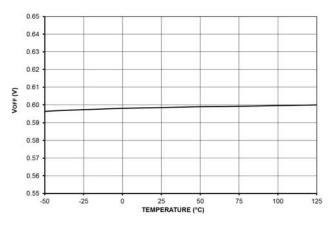


Figure 36. FB Pin Voltage Level Below which is Entered Off Mode V<sub>OFF</sub>

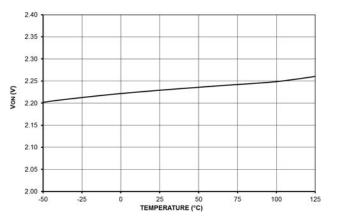


Figure 33. FB Pin Voltage Level Above which is Entered Normal Operating Mode V<sub>ON</sub>

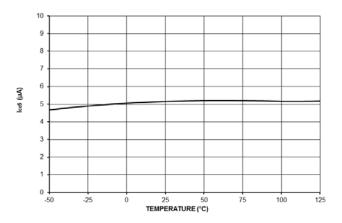


Figure 35. Internal Current Consumption in Off Mode I<sub>CC5</sub>

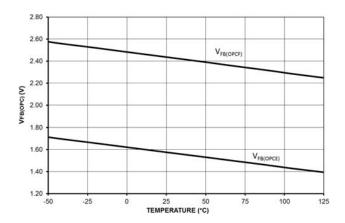


Figure 37. FB Pin Voltage Thresholds for Overpower Compensation

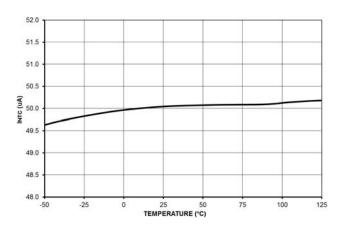


Figure 39. Current  $I_{\mbox{NTC}}$  Sourced Out from the Fault Pin, allowing Direct NTC Connection

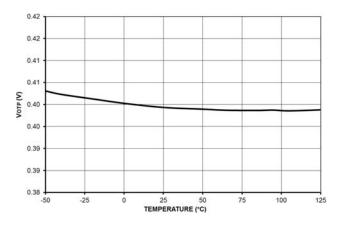


Figure 41. Fault Pin Low Threshold for OTP VOTP

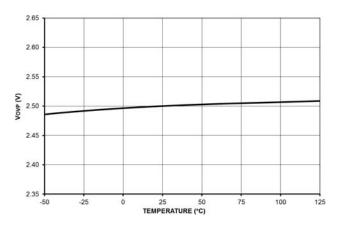


Figure 38. Fault Pin High Threshold for OVP  $V_{OVP}$ 

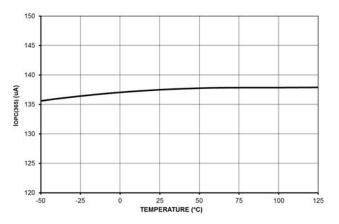
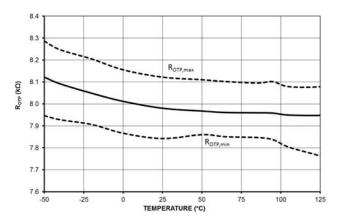


Figure 40. Current Flowing Out from CS Pin for Over Power Compensation @ 365 V at HV Pin I<sub>OPC(365)</sub>



NOTE: The OTP resistance maximum and minimum courses are not the guaranteed limits, but the maximum and minimum measured data values from the device characterization.

Figure 42. The OTP Resistance Threshold R<sub>OTP</sub>

## **APPLICATION INFORMATION**

#### **Functional Description**

The NCP12400 includes all necessary features to build a safe and efficient power supply based on a fixed-frequency flyback converter. The NCP12400 is a multimode controller as illustrated in Figure 43. The mode of operation depends upon line and load condition. Under all modes of operation, the NCP12400 terminates the DRV signal based on the switch current. Thus, the NCP12400 always operates in current mode control so that the power MOSFET current is always limited.

Under normal operating conditions, the FB pin commands the operating mode of the NCP12400 at the voltage thresholds shown in Figure 43. At normal rated operating loads (from 100% to approximately 33% full rated power) the NCP12400 controls the converter in a fixed–frequency PWM mode. It can operate in the continuous conduction mode (CCM) or discontinuous conduction mode (DCM) depending upon the input voltage and loading conditions. If the controller is used in CCM with a wide input voltage range, the duty–ratio may increase up to 50%. The build–in slope compensation prevents the appearance of sub–harmonic oscillations in this operating area. For loads that are between approximately 32% and 10% of full rated power, the converter operates in frequency foldback mode (FFM). If the feedback pin voltage is lower than 1.4 V the peak switch current is kept constant and the output voltage is regulated by modulating the switching frequency for a given and fixed input voltage V<sub>HV</sub>.

Effectively, operation in FFM results in the application of constant volt-seconds to the flyback transformer each switching cycle. Voltage regulation in FFM is achieved by varying the switching frequency in the range from 65 kHz to 28 kHz. For extremely light loads (below approximately 6% full rated power), the converter is controlled using bursts of 28 kHz pulses. This mode is known as skip mode. The FFM, keeping constant peak current and skip mode allows design of the power supplies with increased efficiency under the light loading conditions. Keep in mind that the aforementioned boundaries of steady-state operation are approximate because they are subject to converter design parameters.

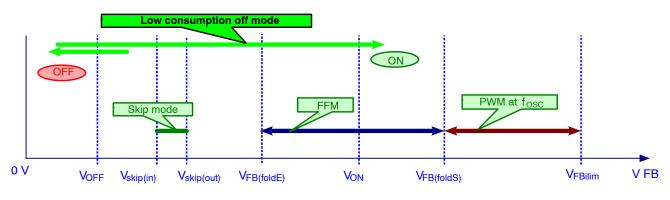
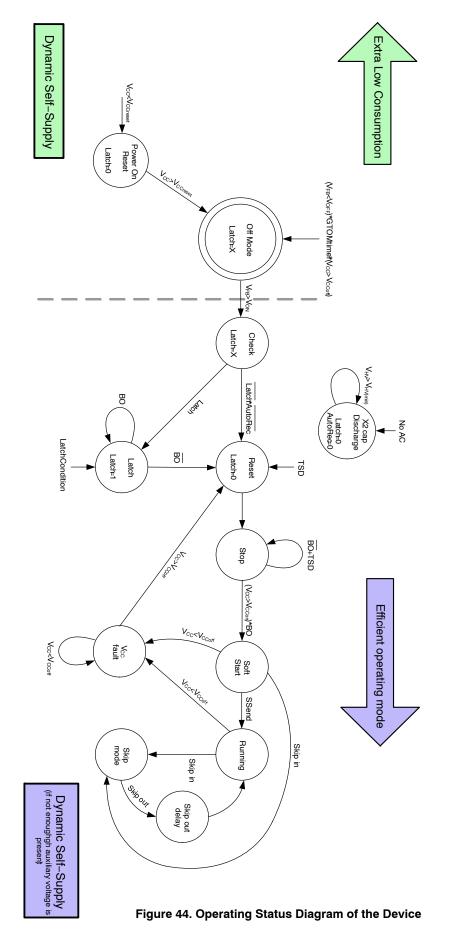


Figure 43. Mode Control with FB Pin Voltage

There was implemented the low consumption off mode allowing to reach extremely low no load input power. This mode is controlled by the FB pin and allows the remote control (or secondary side control) of the power supply shut–down. Most of the device internal circuitry is unbiased in the low consumption off mode. Only the FB pin control circuitry and X2 cap discharging circuitry is operating in the low consumption off mode. If the voltage at feedback pin decreases below the 0.6 V the controller will enter the low consumption off mode. The controller can start if the FB pin voltage increases above the 2.2 V level.

See the detailed status diagrams for the both versions fully latched A and the autorecovery B on the following figures. The basic status of the device after wake–up by the  $V_{CC}$  is the off mode and mode is used for the overheating protection mode if the thermal shutdown protection is activated.



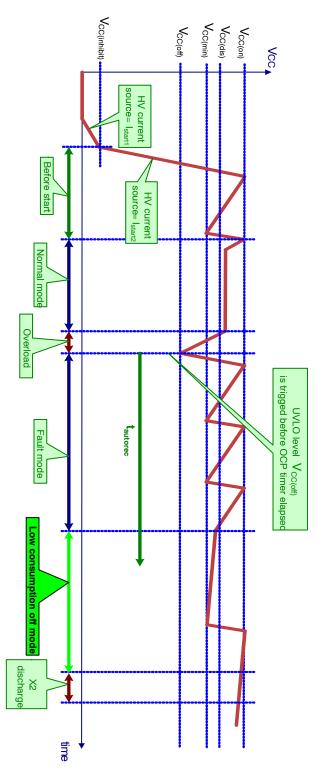


Figure 45. V<sub>CC</sub> Management Timing Diagram

The information about the fault (permanent Latch or Autorecovery) is kept during the low consumption off mode due the safety reason. The reason is not to allow unlatch the device by the remote control being in off mode.

### Start-up of the Controller

At start-up, the current source turns on when the voltage on the HV pin is higher than  $V_{HV(min)}$ , and turns off when  $V_{CC}$  reaches  $V_{CC(on)}$ , then turns on again when  $V_{CC}$  reaches

 $V_{CC(min)}$ , until the input voltage is high enough to ensure a proper start-up, i.e. when  $V_{HV}$  reaches  $V_{HV(start)}$ . The controller actually starts the next time  $V_{CC}$  reaches  $V_{CC(on)}$ . The controller then delivers pulses, starting with a soft-start period  $t_{SSTART}$  during which the peak current linearly increases before the current-mode control takes over.

Even though the Dynamic Self–Supply is able to maintain the  $V_{CC}$  voltage between  $V_{CC(on)}$  and  $V_{CC(min)}$  by turning the HV start–up current source on and off, it can only be used in light load condition, otherwise the power dissipation on the die would be too much. As a result, an auxiliary voltage source is needed to supply  $V_{CC}$  during normal operation.

The Dynamic Self–Supply is useful to keep the controller alive when no switching pulses are delivered, e.g. in brown–out condition, or to prevent the controller from stopping during load transients when the  $V_{CC}$  might drop. The NCP12400 accepts a supply voltage as high as 28 V, with an overvoltage threshold  $V_{CC(ovp)}$  that latches the controller off.

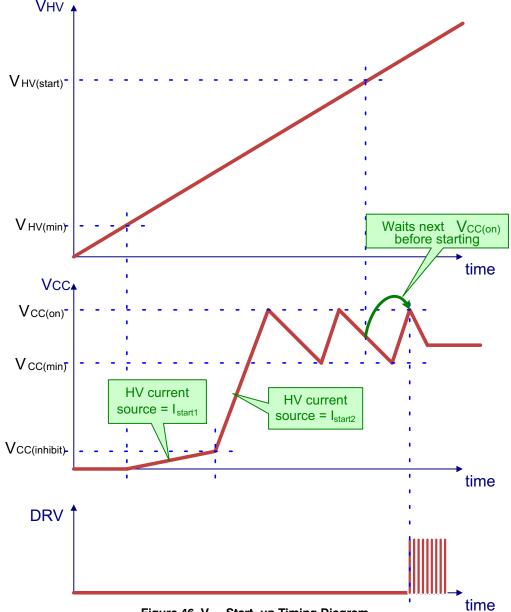
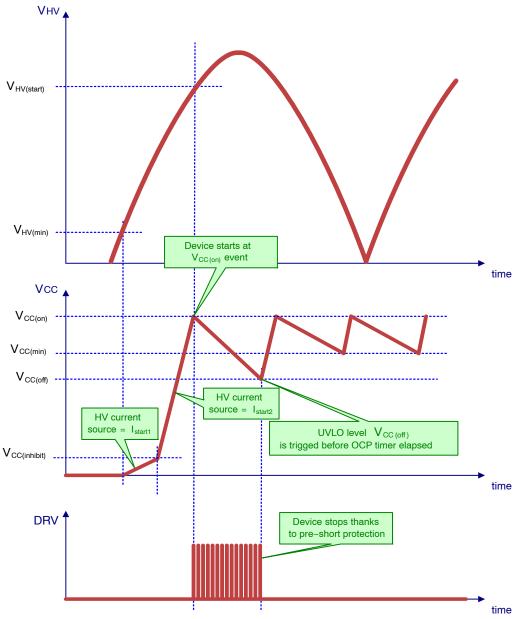


Figure 46. V<sub>CC</sub> Start-up Timing Diagram

For safety reasons, the start–up current is lowered when  $V_{CC}$  is below  $V_{CC(inhibit)}$ , to reduce the power dissipation in case the  $V_{CC}$  pin is shorted to GND (in case of  $V_{CC}$  capacitor failure, or external pull–down on  $V_{CC}$  to disable the

controller). There is only one condition for which the current source doesn't turn on when  $V_{CC}$  reaches  $V_{CC(inhibit)}$ : the voltage on HV pin is too low (below  $V_{HV(min)}$ ).





### HV Sensing of Rectified AC Voltage

The NCP12400 features on its HV pin a true ac line monitoring circuitry. It includes a minimum start-up threshold and an autorecovery brown-out protection; both of them independent of the ripple on the input voltage. It is allowed only to work with an unfiltered, rectified ac input to ensure the X2 capacitor discharge function as well, which is described in following. The brown-out protection thresholds are fixed, but they are designed to fit most of the standard ac-dc conversion applications.

When the input voltage goes below  $V_{HV(stop)}$ , a brown-out condition is detected, and the controller stops. The HV current source maintains  $V_{CC}$  between  $V_{CC(on)}$  and  $V_{CC(min)}$  levels until the input voltage is back above  $V_{HV(start)}$ .

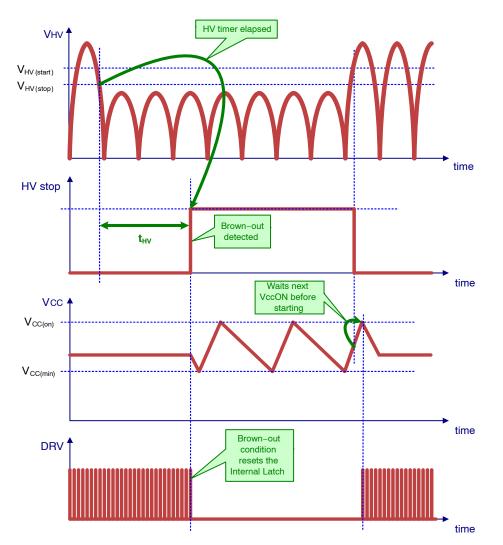


Figure 48. Ac Line Drop-out Timing Diagram

When  $V_{HV}$  crosses the  $V_{HV(start)}$  threshold, the controller can start immediately. When it crosses  $V_{HV(stop)}$ , it triggers a timer of duration  $t_{HV}$ , this ensures that the controller doesn't stop in case of line cycle drop-out.

When  $V_{HV}$  crosses the  $V_{HV(start)}$  threshold, the controller starts when the  $V_{CC}$  crosses the next  $V_{CC(on)}$  event. When it crosses  $V_{HV(stop)}$ , it triggers a timer of duration  $t_{HV}$ , this ensures that the controller doesn't stop in case of line cycle drop-out. The device restart after the ac line voltage drop-out is protected to the parasitic restart initiated e.g. the spikes induced at HV pin immediately after the device is stopped by the residual energy in the EMI filter. The device restart is allowed only after the 1<sup>st</sup> watch dog signal event. The basic principle is shown at Figure 49 and detail of the device restart is shown at Figure 50.

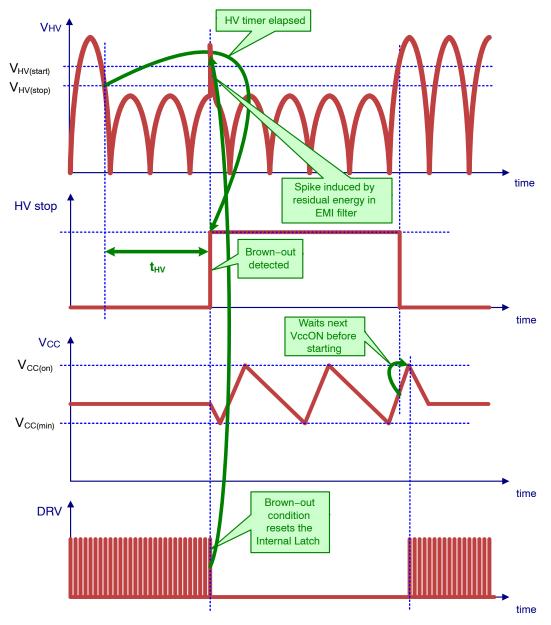


Figure 49. Ac Line Drop-out Timing Diagram with the Parasitic Spike

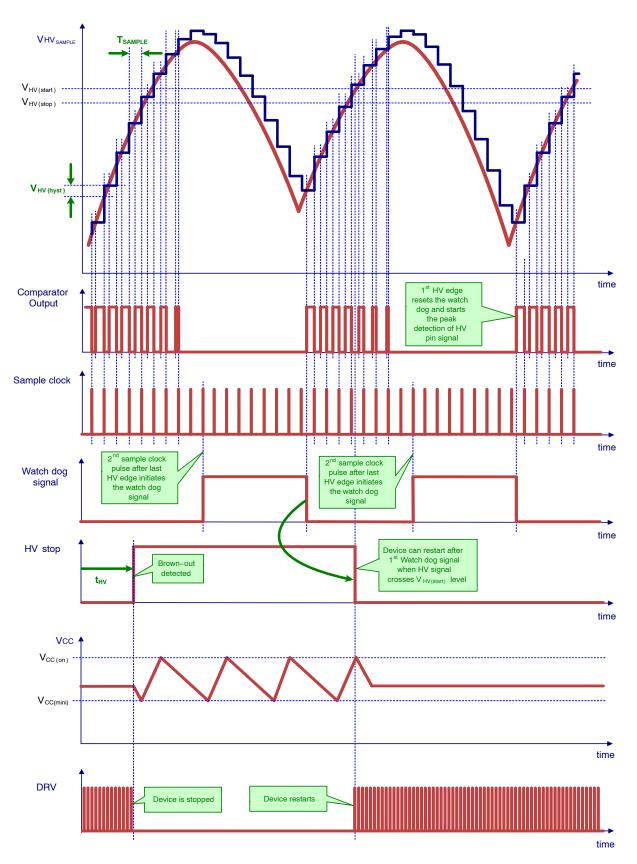


Figure 50. Detailed Timing Diagram of the Device Restart after the Short ac Line Drop-out

#### X2 Cap Discharge Feature

The X2 capacitor discharging feature is offered by usage of the NCP12400. This feature save approx. 16 mW – 25 mW input power depending on the EMI filter X2 capacitors volume and it saves the external components count as well. The discharge feature is ensured via the start–up current source with a dedicated control circuitry for this function. The X2 capacitors are being discharged by current defined as  $I_{start2}$  when this need is detected.

There is used a dedicated structure called ac line unplug detector inside the X2 capacitor discharge control circuitry. See the Figure 51 for the block diagram for this structure and Figures 52, 53, 54 and 55 for the timing diagrams. The basic idea of ac line unplug detector lies in comparison of the direct sample of the high voltage obtained via the high voltage sensing structure with the delayed sample of the high voltage. The delayed signal is created by the sample & hold structure.

The comparator used for the comparison of these signals is without hysteresis inside. The resolution between the slopes of the ac signal and dc signal is defined by the sampling time T<sub>SAMPLE</sub> and additional internal offset N<sub>OS</sub>. These parameters ensure the noise immunity as well. The additional offset is added to the picture of the sampled HV signal and its analog sum is stored in the C1 storage capacitor. If the voltage level of the HV sensing structure output crosses this level the comparator CMP output signal resets the detection timer and no dc signal is detected. The additional offset NOS can be measured as the VHV(hvst) on the HV pin. If the comparator output produces pulses it means that the slope of input signal is higher than set resolution level and the slope is positive. If the comparator output produces the low level it means that the slope of input signal is lower than set resolution level or the slope is negative. There is used the detection timer which is reset by any edge of the comparator output. It means if no edge comes before the timer elapses there is present only dc signal or signal with the small ac ripple at the HV pin. This type of the ac detector detects only the positive slope, which fulfils the requirements for the ac line presence detection.

In case of the dc signal presence on the high voltage input, the direct sample of the high voltage obtained via the high voltage sensing structure and the delayed sample of the high voltage are equivalent and the comparator produces the low level signal during the presence of this signal. No edges are present at the output of the comparator, that's why the detection timer is not reset and dc detect signal appears.

The minimum detectable slope by this ac detector is given by the ration between the maximum hysteresis observed at HV pin  $V_{HV(hyst),max}$  and the sampling time:

$$S_{min} = \frac{V_{HV(hyst),max}}{T_{sample}}$$
 (eq. 1)

Than it can be derived the relationship between the minimum detectable slope and the amplitude and frequency of the sinusoidal input voltage:

$$V_{\text{max}} = \frac{V_{\text{HV(hyst),max}}}{2 \cdot \pi \cdot f \cdot T_{\text{sample}}} = \frac{5}{2 \cdot \pi \cdot 35 \cdot 1 \cdot 10^{-3}} =$$
$$= 22.7 \text{ V} \tag{eq. 2}$$

The minimum detectable AC RMS voltage is 16 V at frequency 35 Hz, if the maximum hysteresis is 5 V and sampling time is 1 ms.

The X2 capacitor discharge feature is available in any controller operation mode to ensure this safety feature. The detection timer is reused for the time limiting of the discharge phase, to protect the device against overheating. The discharging process is cyclic and continues until the ac line is detected again or the voltage across the X2 capacitor is lower than  $V_{HV(min)}$ . This feature ensures to discharge quite big X2 capacitors used in the input line filter to the safe level. It is important to note that it is not allowed to connect HV pin to any dc voltage due this feature. e.g. directly to bulk capacitor.

During the HV sensing or X2 cap discharging the  $V_{CC}$  net is kept above the  $V_{CC(off)}$  voltage by the Self–Supply in any mode of device operation to supply the control circuitry. During the discharge sequence is not allowed to start–up the device.

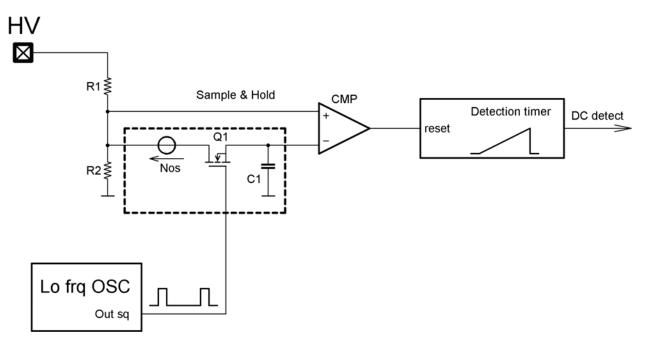


Figure 51. The ac Line Unplug Detector Structure Used for X2 Capacitor Discharge System

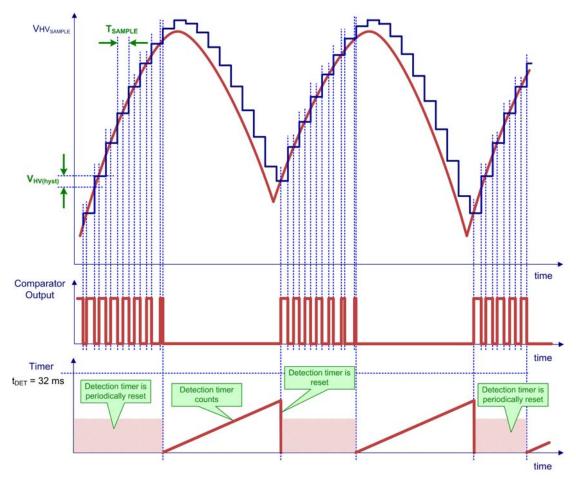


Figure 52. The ac Line Unplug Detector Timing Diagram

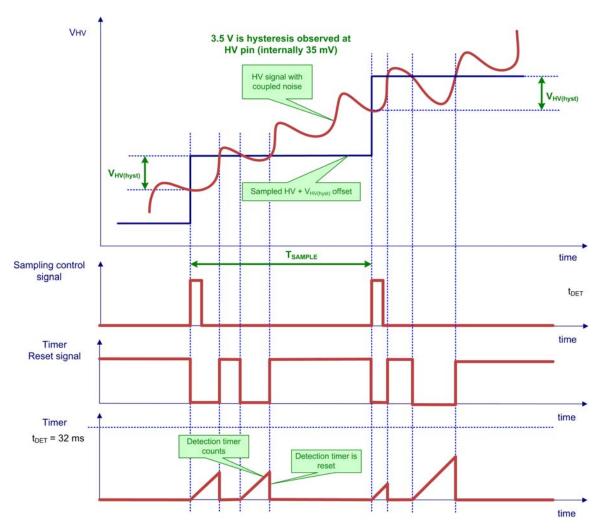


Figure 53. The ac Line Unplug Detector Timing Diagram Detail with Noise Effects

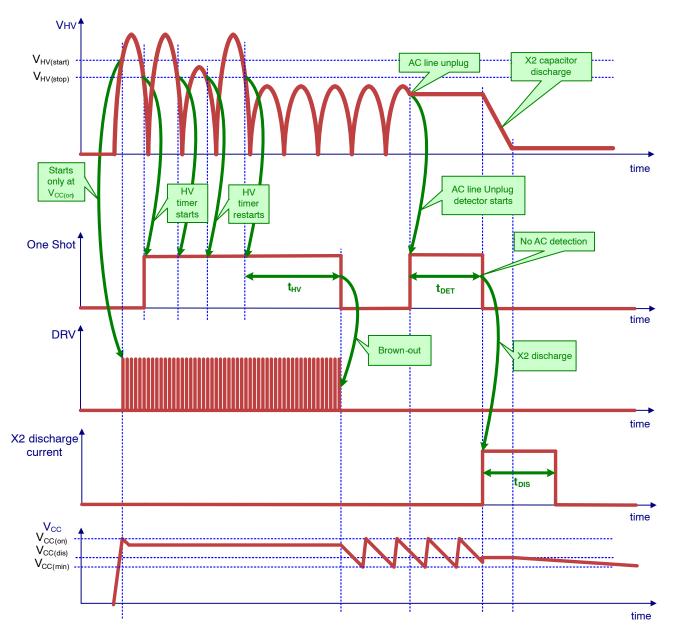


Figure 54. HV Pin ac Input Timing Diagram with X2 Capacitor Discharge Sequence when the Application is Unplugged Under Extremely Low Line Condition

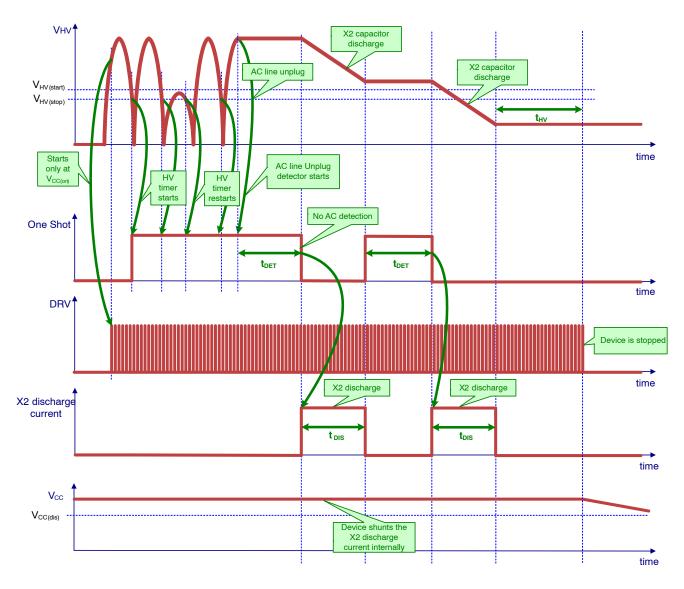


Figure 55. HV Pin ac Input Timing Diagram with X2 Capacitor Discharge Sequence When the Application is Unplugged Under High Line Condition

#### The Low Consumption Off Mode

There was implemented the low consumption off mode allowing to reach extremely low no load input power as described in previous chapters. If the voltage at feedback pin decreases below the 0.6 V the controller enters the off mode. The internal  $V_{CC}$  is turned–off, the IC consumes extremely low  $V_{CC}$  current and only the voltage at external  $V_{CC}$  capacitor is maintained by the Dynamic Self–Supply circuit. The Dynamic Self–Supply circuit keeps the  $V_{CC}$  voltage between the  $V_{CC(on)}$  and  $V_{CC(off)}$  levels. The supply for the FB pin watch dog circuitry and FB pin bias is provided via the low consumption current sources from the external  $V_{CC}$  capacitor. The controller can only start, if the FB pin voltage increases above the 2.2 V level. See Figure 56 for timing diagrams.

Only the X2 cap discharge and Self–Supply features is enabled in the low consumption off mode. The X2 cap discharging feature is enable due the safety reasons and the Self–Supply is enabled to keep the  $V_{CC}$  supply, but only very low  $V_{CC}$  consumption appears in this mode. Any other features are disabled in this mode.

The information about the latch status of the device is kept in the low consumption off mode and this mode is used for the TSD protection as well. The protection timer GoToOffMode  $t_{GTOM}$  is used to protect the application against the false activation of the low consumption off mode by the fast drop outs of the FB pin voltage below the 0.4 V level. E.g. in case when is present high FB pin voltage ripple during the skip mode.

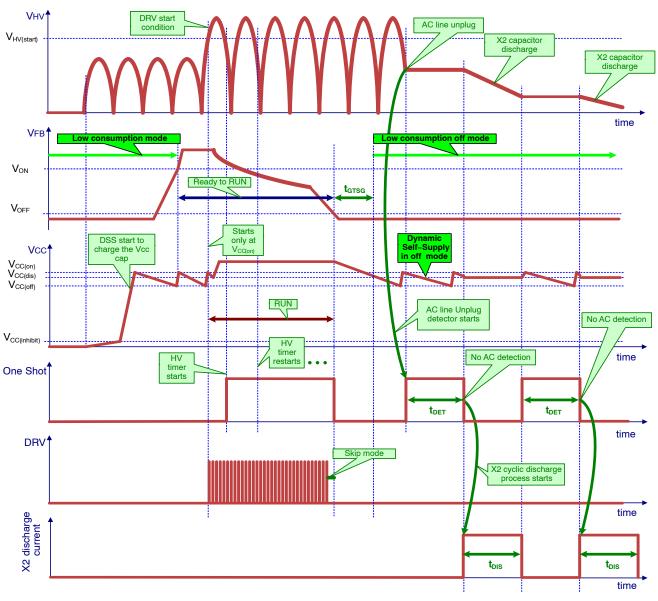


Figure 56. Start-up, Shut-down and AC Line Unplug Time Diagram

### **Oscillator with Frequency Jittering**

The NCP12400 includes an oscillator that sets the switching frequency to 65 kHz. The maximum duty ratio is 80% with precision  $\pm 5\%$ . In order to improve the EMI signature, the switching frequency jitters  $\pm 4$  kHz around its nominal value, with a triangle–wave shape and at a frequency of 125 Hz. This frequency jittering is active even when the frequency is decreased to improve the efficiency in light load condition.

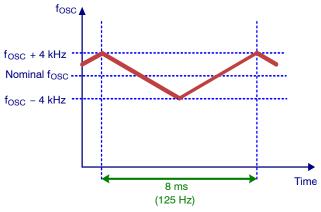


Figure 57. Frequency Modulation of the Maximum Switching Frequency

# Low Load Operation Modes: Frequency Foldback Mode (FFM) and Skip Mode

In order to improve the efficiency in light load conditions, the frequency of the internal oscillator is linearly reduced from its nominal value down to f<sub>OSC(min)</sub>. This frequency foldback starts when the voltage on FB pin goes below  $V_{FB(foldS)}$ , and is complete when  $V_{FB}$  reaches  $V_{FB(foldE)}$ . The frequency jittering is still active while the oscillator frequency decreases as well. The current setpoint is fixed to 300 mV in the frequency foldback mode if the feedback voltage decreases below the  $V_{FB(freeze)}$  level. This feature increases efficiency under the light loads conditions as well.

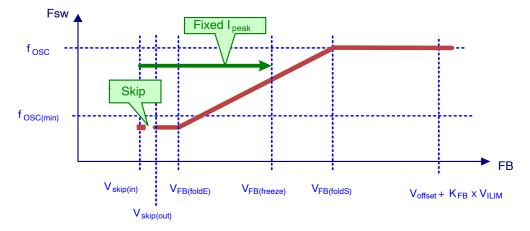


Figure 58. Frequency Foldback Mode Characteristic

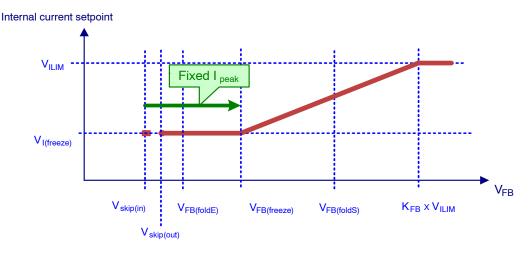
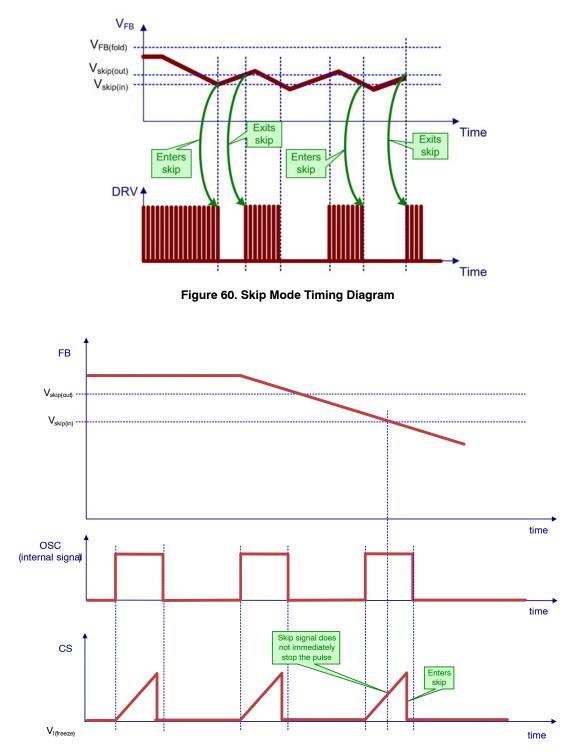


Figure 59. Current Setpoint Dependency on the Feedback Pin Voltage

When the FB voltage reaches  $V_{skip(in)}$  while decreasing, skip mode is activated: the driver stops, and the internal consumption of the controller is decreased. While  $V_{FB}$  is below  $V_{skip(out)}$ , the controller remains in this state; but as soon as  $V_{FB}$  crosses the skip out threshold, the DRV pin starts to pulse again.

The NCP12400 device includes logic which allows going into skip mode after the DRV cycle is finished by reaching of the peak current value. This technique eliminates the last short pulses in skip mode, which increases the system efficiency at light loads and makes easier the application of active secondary rectification circuitry.





#### **Clamped Driver**

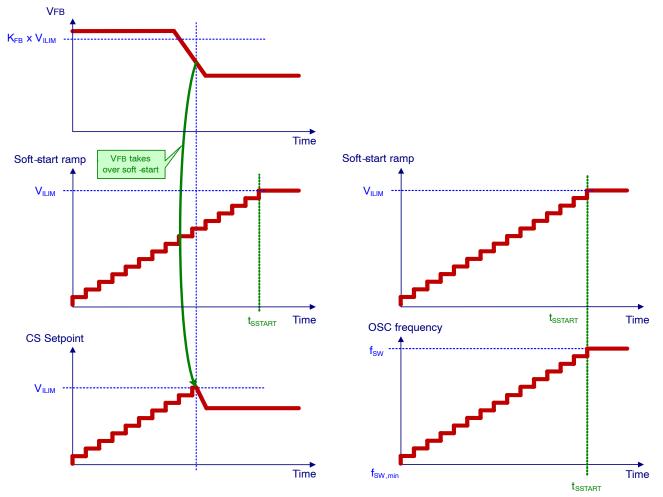
The supply voltage for the NCP12400 can be as high as 28 V, but most of the MOSFETs that will be connected to the DRV pin cannot accept more than 20 V on their gate. The driver pin is therefore safely clamped below 16 V. This driver has a typical capability of 500 mA for source current and 800 mA for sink current.

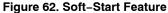
# Current-Mode Control With Slope Compensation and Soft-Start

NCP12400 is a current-mode controller, which means that the FB voltage sets the peak current flowing in the transformer primary inductance and the MOSFET. This is done through a PWM comparator: the current is sensed across a resistor and the resulting voltage is applied to the CS pin. It is applied to one input of the PWM comparator through a 250 ns LEB block. On the other input the FB voltage subducted by offset typically 0.8 V and divided by 4 sets the threshold: when the voltage ramp reaches this threshold, the output driver is turned off. The maximum value for the current sense is 0.7 V, and it is set by a dedicated comparator.

Each time the controller is starting, i.e. the controller was off and starts – or restarts – when  $V_{CC}$  reaches  $V_{CC(on)}$ , a soft–start is applied: the current sense set–point is increased by 32 discrete steps from 0 (the minimum level can be higher than 0 because of the LEB and propagation delay) until it reaches  $V_{ILIM}$  (after a duration of  $t_{SSTART}$ ), or until the FB loop imposes a setpoint lower than the one imposed by the soft–start (the 2 comparators outputs are OR'ed).

During the soft-start the oscillator frequency increase from the minimum switching frequency to the maximum switching frequency following the ramp applied to current sense set-point.





Under some conditions, like a winding short-circuit for instance, not all the energy stored during the on-time is transferred to the output during the off-time, even if the on-time duration is at its minimum (imposed by the propagation delay of the detector added to the LEB duration). As a result, the current sense voltage keeps on increasing above  $V_{ILIM}$ , because the controller is blind during the LEB blanking time. Dangerously high current can grow in the system if nothing is done to stop the controller. That's what the additional comparator, that senses when the current sense voltage on CS pin reaches  $V_{CS(stop)}$  (= 1.5 x V<sub>ILIM</sub>), does: as soon as this comparator toggles, the controller immediately enters the protection mode.

In order to allow the NCP12400 to operate in CCM with a duty-ratio above 50%, the fixed slope compensation is internally applied to the current-mode control. The slope appearing on the internal voltage setpoint for the PWM comparator is -32.5 mV/µs typical. The slope compensation can be observable as a value of the peak current at CS pin. The internal slope compensation circuitry uses a saw-tooth signal synchronized with the internal oscillator is subtracted from the FB voltage divided by K<sub>FB</sub>.

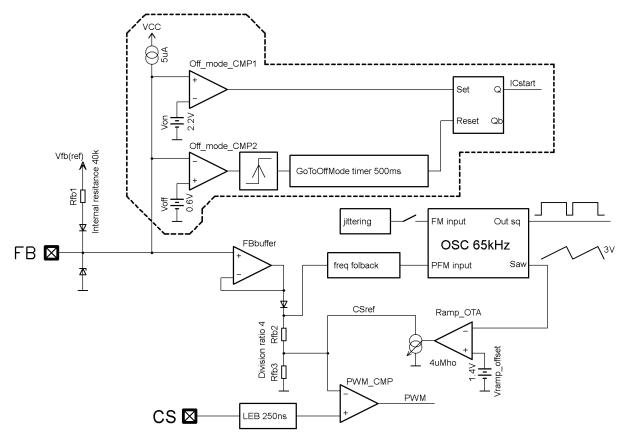


Figure 63. Slope Compensation Block Diagram

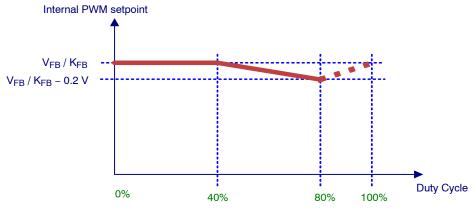


Figure 64. Slope Compensation Timing Diagram

#### **Internal Overpower Protection**

The power delivered by a flyback power supply is proportional to the square of the peak current in discontinuous conduction mode:

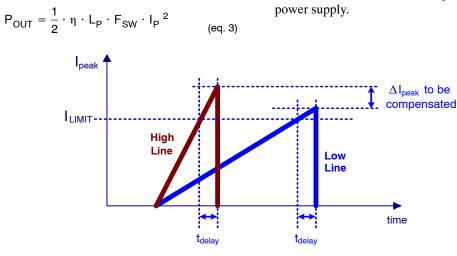


Figure 65. Needs for Line Compensation For True Overpower Protection

To compensate this and have an accurate overpower protection, an offset proportional to the input voltage is added on the CS signal by turning on an internal current source: by adding an external resistor in series between the sense resistor and the CS pin, a voltage offset is created across it by the current. The compensation can be adjusted by changing the value of the resistor. But this offset is unwanted to appear when the current sense signal is small, i.e. in light load conditions, where it would be in the same order of magnitude. Therefore the compensation current is only added when the FB voltage is higher than  $V_{FB(OPCE)}$ . However, because the HV pin is being connected to ac voltage, there is needed an additional circuitry to read or at least closely estimate the actual voltage on the bulk capacitor.

Unfortunately, due to the inherent propagation delay of

the logic, the actual peak current is higher at high input

voltage than at low input voltage, leading to a significant

difference in the maximum output power delivered by the

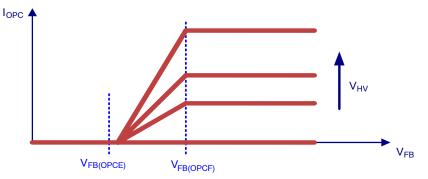


Figure 66. Overpower Protection Current Relation to Feedback Voltage

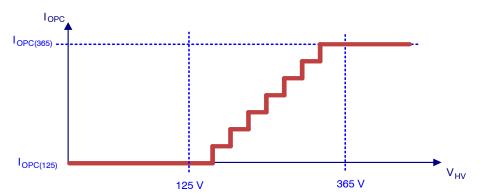
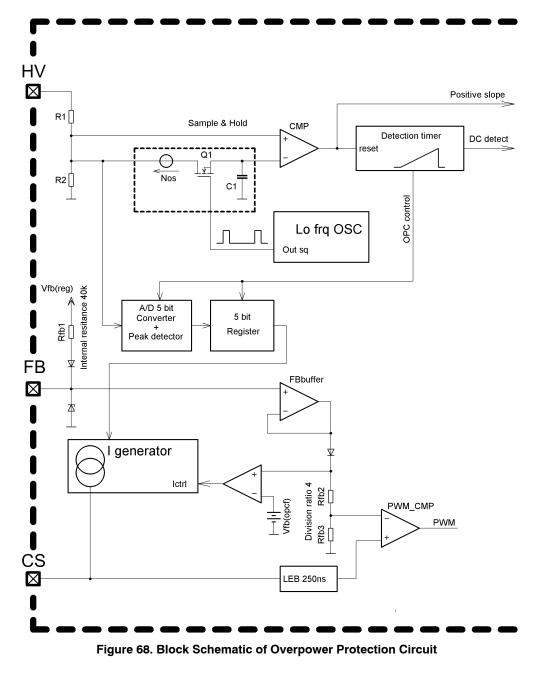


Figure 67. Overpower Protection Current Relation to Peak of Rectified Input Line AC voltage



A 5-bit A/D converter with the peak detector senses the ac input, and its output is periodically sampled and reset, in order to follow closely the input voltage variations. The sample and reset events are given by the output from the ac line unplug detector. The sensed HV pin voltage peak value is validated when no HV edges from comparator are present after last falling edge during 2 sample clocks. See Figure 69 for details.

### **Overcurrent Protection with Fault timer**

The overload protection depends only on the current sensing signal, making it able to work with any transformer, even with very poor coupling or high leakage inductance. When an overcurrent occurs on the output of the power supply, the FB loop asks for more power than the controller can deliver, and the CS set–point reaches  $V_{ILIM}$ . When this event occurs, an internal  $t_{fault}$  timer is started: once the timer times out, DRV pulses are stopped and the controller is latched off. Other possibilities of the latch release are the brown–out condition or the  $V_{CC}$  power on reset. The timer is reset when the CS set–point goes back below  $V_{ILIM}$  before the timer elapses. The controller also enters the same protection mode if the voltage on the CS pin reaches 1.5 times the maximum internal set–point  $V_{CS(stop)}$  (allows to detect winding short–circuits) or there appears low  $V_{CC}$  supply. See Figure 69 for the timing diagrams.

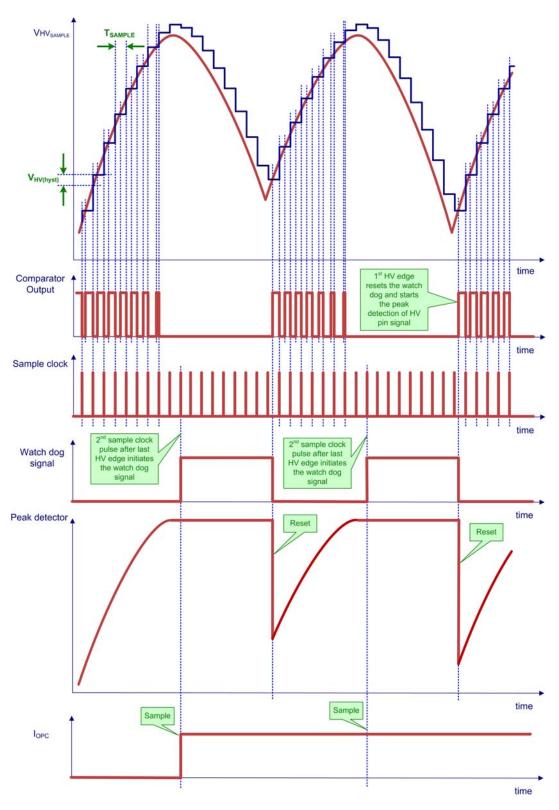


Figure 69. Overpower Compensation Timing Diagram

Event	Timer Protection	Next Device Status	Release to Normal Operation Mode
Overcurrent V <sub>CS</sub> > V <sub>ILIM</sub>	Fault timer	Latch	Brown–out V <sub>CC</sub> < V <sub>CC(reset)</sub>
Maximum duty cycle	Fault timer	Latch	Brown–out V <sub>CC</sub> < V <sub>CC(reset)</sub>
Winding short $V_{CS} > V_{CS(stop)}$	4 consecutive pulses	Latch	Brown–out V <sub>CC</sub> < V <sub>CC(reset)</sub>
Low supply $V_{CC} < V_{CC(off)}$	10 μs timer	Latch	Autorecovery Brown–out V <sub>CC</sub> < V <sub>CC(reset)</sub>
External OTP, OVP	55 μs	Latch	Brown–out V <sub>CC</sub> < V <sub>CC(reset)</sub>
High supply $V_{CC} > V_{CC(ovp)}$	10 μs timer	Latch	Brown–out V <sub>CC</sub> < V <sub>CC(reset)</sub>
Brown–out V <sub>HV</sub> < V <sub>HV(stop)</sub>	HV timer	Device stops	$(V_{HV} > V_{HV(start)}) \& (V_{CC} > V_{CC(on)})$
Internal TSD	10 μs timer	Device stops, HV start-up current source stops	(V <sub>HV</sub> > V <sub>HV(start)</sub> ) & (V <sub>CC</sub> > V <sub>CC(on)</sub> ) & TSDb
Off mode V <sub>FB</sub> < V <sub>OFF</sub>	500 ms timer	Device stops and internal V <sub>CC</sub> is turned off	$\begin{array}{c} (V_{HV} > V_{HV(start)}) \And (V_{CC} > V_{CC(on)}) \And \\ (V_{FB} > V_{ON}) \end{array}$

## Table 5. PROTECTION MODES AND THE LATCH MODE RELEASES

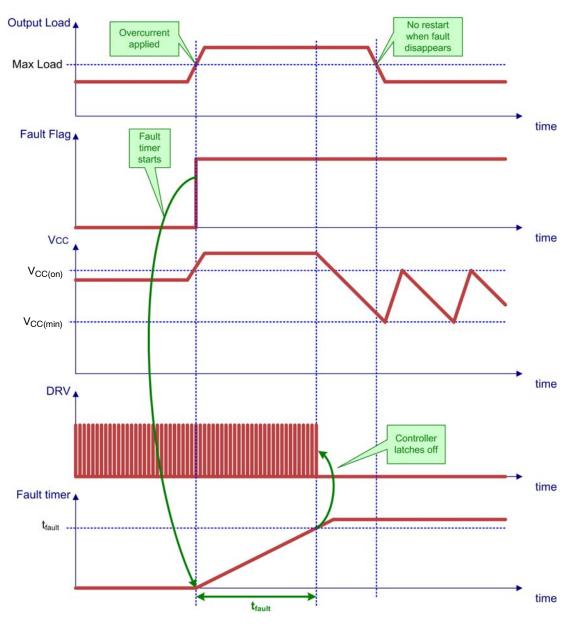


Figure 70. Latched Timer-Based Overcurrent Protection

#### **FAULT Input**

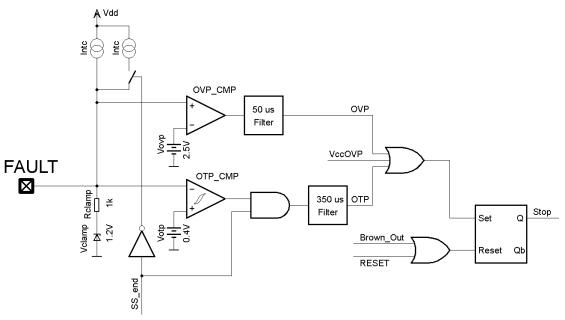


Figure 71. OVP/OTP Detection Schematic

The FAULT input pin is dedicated to the latch-off function: it includes 2 levels of detection that define a working window, between a high latch and a low latch: within these 2 thresholds, the controller is allowed to run, but as soon as either the low or the high threshold is crossed, the controller is latched off. The lower threshold is intended to be used with an NTC thermistor, thanks to an internal current source  $I_{NTC}$ .

An active clamp prevents the voltage from reaching the high threshold if it is only pulled up by the  $I_{NTC}$  current. To reach the high threshold, the pull-up current has to be higher than the pull-down capability of the clamp (typically 1.5 mA at  $V_{OVP}$ ).

To avoid any false triggering, spikes shorter than 50  $\mu$ s are blanked and only longer signals can actually latch the controller.

Reset occurs when a brown–out condition is detected or the  $V_{CC}$  is cycled down to a reset voltage, which in a real

application can only happen if the power supply is unplugged from the ac line.

Upon startup, the internal references take some time before being at their nominal values; so one of the comparators could toggle even if it should not. Therefore the internal logic does not take the latch signal into account before the controller is ready to start: once  $V_{CC}$  reaches  $V_{CC(on)}$ , the latch pin High latch state is taken into account and the DRV switching starts only if it is allowed; whereas the Low latch (typically sensing an over temperature) is taken into account only after the soft–start is finished. In addition, the NTC current is doubled to  $I_{NTC(SSTART)}$  during the soft–start period, to speed up the charging of the FAULT pin capacitor The maximum value of FAULT pin capacitor is given by the following formula (The standard start–up condition is considered and the NTC current is neglected):

$$C_{FAULT max} = \frac{t_{SSTART min} \cdot I_{NTC(SSTART) min}}{V_{OTP max}} = \frac{3.2 \cdot 10^{-3} \cdot 60 \cdot 10^{-6}}{0.420} F = 457 \text{ nF} \quad (eq. 4)$$

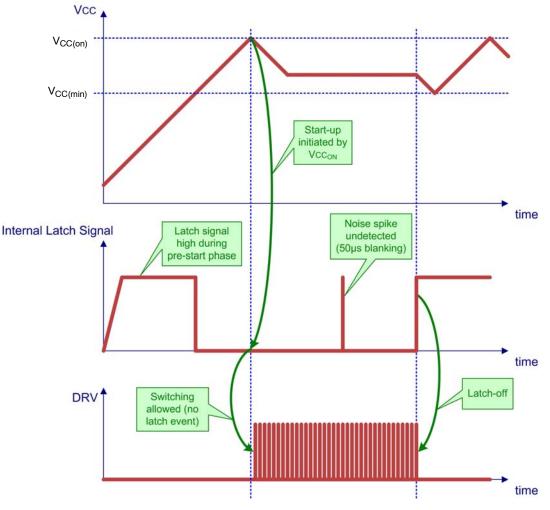


Figure 72. Latch Timing Diagram

### Temperature Shutdown

The NCP12400 includes a temperature shutdown protection with a trip point typically at 150°C and the typical hysteresis of 30°C. When the temperature rises above the high threshold, the controller stops switching instantaneously, and goes to the off mode with extremely

low power consumption. There is kept the  $V_{CC}$  supply to keep the TSD information. When the temperature falls below the low threshold, the start-up of the device is enabled again, and a regular start-up sequence takes place. See the status diagrams at the Figure 44.

## **ORDERING INFORMATION**

Ordering Part No.	<b>Overload Protection</b>	Switching Frequency	Package	Shipping <sup>†</sup>
NCP12400BAHAB0DR2G	Latched	65 kHz	SOIC-7 (Pb-Free)	2500 / Tape & Reel

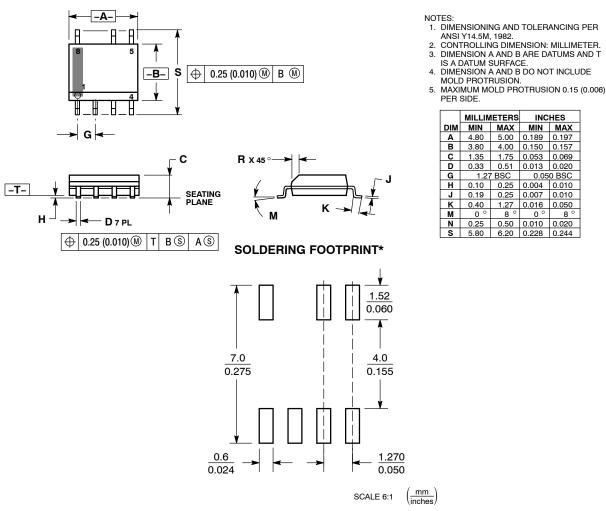
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **IP Disclosure**

The product described herein (NCP12400) may be covered by one or more of the following U.S. patents: 5,073,850, 6,271,735, 6,362,067, 6,385,060, 6,597,221, 6,633,193, 6,587,351, 6,940,320. There may be other patents pending.

#### PACKAGE DIMENSIONS





\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and ware trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <a href="https://www.onsemi.com/site/pdf/Patent-Marking.pdf">www.onsemi.com/site/pdf/Patent-Marking.pdf</a>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typical" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

MILLIMETERS

1.27 BSC

3.80

1.35

0.19

0.40

0

5.80

А 4.80

в

J

Ν 0.25

S

MIN MAX MIN MAX

1.75

8 ° 0 °

5.00 0.189

0.33 0.51 0.013 0.020

0.10 0.25 0.004 0.010

4.00 0.150 0.157

0.25 0.007 0.010

1.27 0.016 0.050

0.50 0.010 0.020

6.20 0.228 0.244

INCHES

0.053 0.069

0.050 BSC

0.197

8

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative